Preferred Device

Dual SeriesSwitching Diode

Features

• Pb-Free Packages are Available

MAXIMUM RATINGS (Each Diode)

Rating	Symbol	Value	Unit
Reverse Voltage	V_R	70	Vdc
Forward Current	I _F	215	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc
Repetitive Peak Reverse Voltage	V_{RRM}	70	V
Average Rectified Forward Current (Note 1) (averaged over any 20 ms period)	I _{F(AV)}	715	mA
Repetitive Peak Forward Current	I _{FRM}	450	mA
Non–Repetitive Peak Forward Current t = 1.0 μs t = 1.0 ms t = 1.0 s	I _{FSM}	2.0 1.0 0.5	A

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

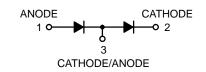
Characteristic	Symbol	Max	Unit
Total Device Dissipation	P _D	225	mW
FR-5 Board (Note 1) T _A = 25°C Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate (Note 2)	P _D	300	mW
T _A = 25°C Derate above 25°C		2.4	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

- 1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = $0.4 \times 0.3 \times 0.024$ in 99.5% alumina.



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CASE 318 SOT-23 STYLE 11

MARKING DIAGRAM



A7 = Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
BAV99LT1	SOT-23	3000/Tape & Reel
BAV99LT1G	SOT-23 (Pb-Free)	3000/Tape & Reel
BAV99LT3	SOT-23	10,000/Tape & Reel
BAV99LT3G	SOT-23 (Pb-Free)	10,000/Tape & Reel

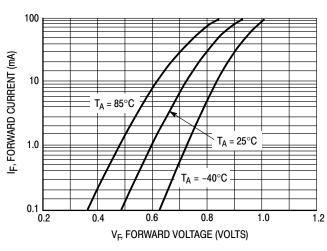
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

OFF CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Each Diode)

Characteristic	Symbol	Min	Max	Unit
Reverse Breakdown Voltage,	,,	70		
$(I_{(BR)} = 100 \mu A)$	$V_{(BR)}$	70	-	Vdc
Reverse Voltage Leakage Current,				
$(V_R = 70 \text{ Vdc})$	I _R	_	2.5 30	μAdc
$(V_R = 25 \text{ Vdc}, T_J = 150^{\circ}\text{C})$ $(V_R = 70 \text{ Vdc}, T_J = 150^{\circ}\text{C})$		_	50	
Diode Capacitance,				
$(V_R = 0, f = 1.0 \text{ MHz})$	C _D	_	1.5	pF
Forward Voltage,				
(I _F = 1.0 mAdc)	V _F	-	715	mVdc
(I _F = 10 mAdc)	ļ	_	855 1000	
$(I_{F} = 50 mAdc)$	ļ	_	1250	
(I _F = 150 mAdc)				
Reverse Recovery Time,				
$(I_F = I_R = 10 \text{ mAdc}, I_{R(REC)} = 1.0 \text{ mAdc}) R_L = 100 \Omega$	t _{rr}	-	6.0	ns
Forward Recovery Voltage,				
$(I_F = 10 \text{ mA}, t_r = 20 \text{ ns})$	V_{FR}	_	1.75	V

CURVES APPLICABLE TO EACH DIODE



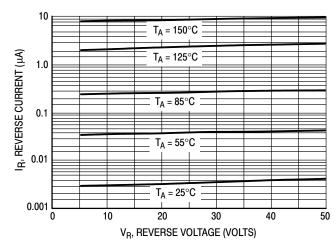


Figure 1. Forward Voltage

Figure 2. Leakage Current

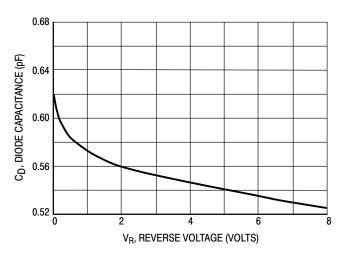
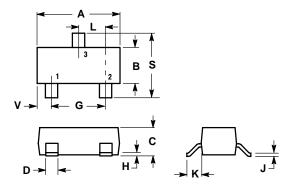


Figure 3. Capacitance

PACKAGE DIMENSIONS

SOT-23 (TO-236) PLASTIC PACKAGE CASE 318-08 ISSUE AK



NOTES

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

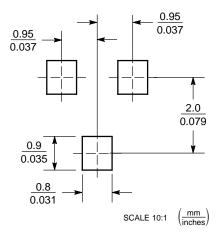
	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.1102	0.1197	2.80	3.04
В	0.0472	0.0551	1.20	1.40
С	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
Н	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

STYLE 11:

PIN 1. ANODE

- 2. CATHODE
- 3. CATHODE-ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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